

VM7000

2 OR 4-CHANNEL, 5-VOLT, FERRITE/MIG HEAD, READ/WRITE PREAMPLIFIER

July, 1993

FEATURES

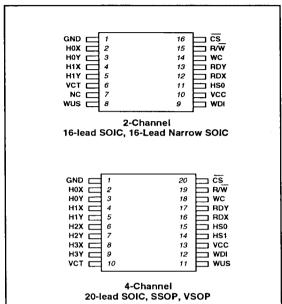
- · High Performance
 - Read Gain = 200 V/V typical
 - Input Noise = 0.85nV/√Hz maximum
 - Head Inductance Range = 1 5 µH
 - Write Current Range 15 50 mA
 - Input Capacitance = 18 pF maximum
- Very Low Power Dissipation = less than 9 mW typical in Sleep Mode
- · Power Up/Down Data Protect Circuitry
- Reduced Write-to-Read Recovery Time
- Single Power Supply = 5 ±10%
- Fault Detect Capability
- Designed for Center-Tapped Ferrite or MIG Heads
- Write Unsafe Detection
- Standard Schottky Isolated 750Ω Damping Resistor
- Available in 2 or 4-Channels

DESCRIPTION

The VM7000 is a high-performance, very low-power read/ write preamplifier designed for use with center-tapped ferrite or MIG recording heads. This circuit will operate on a single 5-volt power supply and is ideally suited for use in battery powered disk drives.

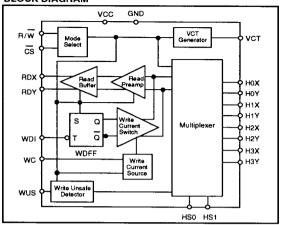
The VM7000 provides write current and data protection circuitry, and low noise read functions for up to four read/write heads. When deactivated, the device enters a *sleep mode* which reduces power dissipation to less than 9 mW typical. Data protection circuitry is provided to ensure that the write current source is totally disabled during power suply power up/power down conditions. Write-to-read recovery time is minimized by eliminating common mode output voltage swings when switching between modes.

CONNECTION DIAGRAMS



VM7000

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Power Supply:	
V _{CC}	0.3V to +7V
Write Current I _W	70mA
Input Voltages:	
Digital Input Voltage V _{IN}	$-0.3V$ to $(V_{CC} + 0.3)V$
Head Port Voltage V _H	
WUS Pin Voltage Range V _{WUS}	0.3V to +6V
Output Current:	
RDX, RDY: Io	10mA
WUS: Iwus	+12mA
Junction Temperature	150°C
Storage Temperature T _{stq}	65° to 150°C
Thermal Characteristics, Θ _{JA} :	
16-lead SOIC	80°C/W
20-lead SOIC	80°C/W

RECOMMENDED OPERATING CONDITIONS

Power Supply Voltage:	
V _{CC}	+5V ± 10%
Write current (I _W)	15 to 50mA
Head Inductance (LH)	
Write Data Frequency Range	24Mbits/sec
Junction Temperature (T _J)	0°C to 125°C

CIRCUIT OPERATION

The VM7000 addresses up to four 3-terminal, center-tapped ferrite or MIG recording heads, providing switched write current in the write mode, or data amplification in the read mode. Head selection and mode control is determined by the head select lines, HS1, HS2 and mode control lines, CS, RW as shown in Tables 1 and 2. Internal resistor pullups, provided on the CS and RW lines, will force the device into a non-write condition if either control line opens up.

Write Mode

In the write mode, the VM7000 acts as a write current switch with the write unsafe (WUS) detection circuitry activated. Write current is toggled between the X and Y side of the selected head on each high to low transition on the Write Data Flip-Flop (WDFF) so that upon switching to the write mode, the write current flows into the "X" side of the head.

The write current magnitude is determined by an external resistor (R_{WC}) connected between the WC pin and Ground. An internally generated reference voltage is present at the WC pin. The magnitude of the write current (0-PK, \pm 8%) is:

$$I_W = 50/R_{WC}$$

Power supply fault protection ensures data security on the disk by disabling the write current source during a power supply voltage fault or by supply power up/down conditions. Additionally, the write unsafe (WUS) detection circuitry will flag any of the conditions listed below, as a high level on the WUS line. Two negative transitions on the WDI pin, after the fault is corrected, are required to clear the WUS line.

- No write current
- · WDI frequency too low
- · Read or sleep mode
- · Open head or center-tap
- Head shorted or shorted to ground
- · Center Tap shorted to ground

Read Mode

In the read mode, the VM7000 acts as a low noise differential amplifier for signals coming off the disk. The write current generator and write unsafe circuitry is deactivated. The RDX, RDY pins are emitter follower outputs and are in phase with "X" and "Y" head ports. These outputs should be AC coupled to the load. The RDX, RDY common mode output voltage is constant, minimizing the transient between read and write mode thereby, substantially reducing the recovery time in the pulse detector circuit connected to these outputs.

Sleep Mode

When \overline{CS} is high, initially all circuitry is shut down so that power dissipation is reduced to 9mW typical in the "Sleep Mode". Switching the \overline{CS} line low "wakes up" the chip and the device will enter the read or write mode, depending on the status of the $\overline{R/W}$ line.

Table 1: Mode Select

HS0	HS1	HEAD
0	0	0
1	0	1
0	1	2
1	1	3

Table 2: Head Select

$\overline{c}\overline{s}$	₽√W	MODE
0	0	Write/Awake
0	1	Read/Awake
1	Х	Sleep

PIN DESCRIPTIONS

PIN DESCRIPTIONS					
NAME	1/0	DESCRIPTION			
HS0-HS1	1*	Head Select: selects one of up to 4 heads			
H0X-H3X H0Y-H3Y	I/O	X, Y Head terminals			
WDI	l*	Write Data Input: TTL input signal, negative transition toggles direction of head current			
cs	I	Chip select: high level signal puts chip in sleep mode, low level wakes chip up			
R/W	l*	Read/Write select: High level selects read mode, low-level selects write mode			
wus	O*	Write unsafe: Open collector output: high level indicates writes unsafe condition			
wc		Write current adjust: A resistor adjusts level of write current			
RDX-RDY	0.	Read data output: differential output data			
VCC		+5 volt supply			
GND		Ground			
VCT	0	Voltage source for head center-tap			

^{*} May be wire-OR'ed for multi-chip usage.

DC CHARACTERISTICS Recommended operating conditions apply unless otherwise specified.

PARAMETER	SYM	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current		Read Mode			42	
	¹ cc	Write Mode			45 + I _W	mA
		Idle Mode			3	
		Read Mode		150	232	
Power Dissipation	PD	Write Mode, I _W = 30mA		335	413	mW
		Idle Mode		7	16.5	
Input High Voltage	V _{IH}		2		V _{CC} +0.3	V
Input Low Voltage	VIL		-0.3		0.8	٧
Input High Current	ΊΗ	V _{IH} = 2.7V			80	μА
Input Low Current	I _{ΙŁ}	$V_{IL} = 0.4V, V_{CC} = 5.5V$	-160			μА
WUS Output Low Voltage	V _{OL}	I _{OL} = 4.0mA			0.5	٧
WUS Output High Current	IOH	V _{OH} = 5.0V			100	μА
VCC Value for Write Current Turn Off		I _W < 1mA	3.7		4.3	V

VM7000

READ CHARACTERISTICS Recommended operating conditions apply unless otherwise specified; C_L (RDX, RDY) ≤ 20pF.

PARAMETER	SYM	CONDITIONS	MIN	TYP	MAX	UNITS
Differential Voltage Gain	Av	V _{IN} = 1mVrms, 1MHz	167	200	233	V/V
Bandwidth	BW	-1dB Zs < 5Ω, V _{IN} = 1mVp-p	25			MHz
Dandwidti	DVV	-3dB Zs $< 5\Omega$, $V_{IN} = 1 \text{mVp-p}$	35			MHz
Input Noise Voltage	e _{in}	BW = 17MHz, L _H = 0, R _H = 0		0.50	0.80	nV/√Hz
Differential Input Capacitance	CIN	V _{IN} = 1mVp-p, f = 5MHz		14	18	pF
Differential Input Resistance	R _{IN}	V _{IN} = 1mVp-p, f = 5MHz	500	1200		Ω
Dynamic Range	DR	AC input voltage where the gain falls to 90% of the gain @ 0.2mVrms input, f = 5MHz	3			mVrms
Common Mode Rejection Ratio	CMRR	V _{IN} = 100mVp-p @5MHz	50			dB
Power Supply Rejection Ratio	PSRR	100mVp-p @5MHz on V _{CC}	45			dB
Channel Separation	cs	Unselected channels driven with 20mVp-p @5MHz Selected Channels V _{IN} = 0mVp-p	45			dB
Output Offset Voltage	vos		-250		+250	mV
RDX,RDY Common Mode Output Voltage	V _{OCM}	Read Mode		1.8		٧
Common Mode Output Voltage Difference, Read vs. Write	△V _{OCM}				350	mV
Single-Ended Output Resistance	R _{SEO}	f = 5MHz			40	Ω
Output Current	Ю	AC Coupled Load, RDX to RDY	±1.5			mA
Center Tap Voltage	V _{CT}			2.7		٧
Input Bias Current (per side)	I _{BIAS}				80	μА

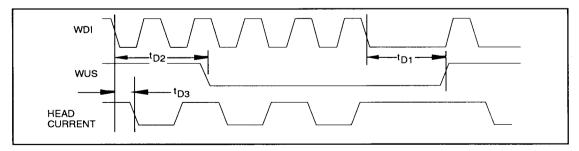


Figure 1: Write Mode Timing Diagram

WRITE CHARACTERISTICS Recommended operating conditions apply unless otherwise specified; $L_H = 5\mu H$, $L_W = 30 mA$, $t_{DATA} = 5 MHz$, $t_{A} = 25 ^{\circ} C$.

PARAMETER	SYM	CONDITIONS	MIN	TYP	MAX	UNITS
WC Pin Voltage	v _{wc}			2.5		V
Differential Head Voltage Swing	v_{DH}		4.8			v
Unselected Head Current	lлн				1	mA(pk)
Write Current Range	lw	1.0K < R _{WC} < 3.3kΩ	15		50	mA
Write Current Tolerance	ΔlW	lw range 10mA to 40mA	-8		+8	%
Differential Output Capacitance	CIN				10	pF
Differential Output Resistance	R _{IN}		750			Ω
Center Tap Voltage	V _{CT}			V _{CC} -0.25		V
Head Current (per side)	lН	0 ≤ VCC ≤ 3.5V	-200	***	200	μА
Write Current Constant	κ _W			50		V
RDX, RDY Leakage Current	ال		-100		100	μА
RDX, RDY Common Mode Output Voltage	V _{СМ}			1.8		V
I _{WC} to head current gain				20		mA/mA

SWITCHING CHARACTERISTICS Recommended operating conditions apply unless otherwise specified; $I_W = 30 \text{mA}$, $f_{\text{DATA}} = 5 \text{MHz}$, $L_H = 5 \mu \text{H}$, C_L (RDX, RDY) $\leq 20 \text{pF}$, $T_A = 25 ^{\circ} \text{C}$.

PARAMETER	SYM	CONDITIONS	MIN	TYP	MAX	UNITS
R/W Read to Write	t _{RW}	R/₩ to 90% I _W			1.0	μs
R/W Write to Read	twR	R/W to 90% of 100mV, 10MHz read signal envelope			1.0	μs
CS Unselect to Select	^t IR	CS to 90% I _W or 90% of 100mV, 10MHz read signal envelope			0.6	μs
CS Select to Unselect	t _{RI}				0.6	μs
HS0, 1, any Head	lw	HS0, 1 to 90% of 100mV, 10MHz read signal envelope			0.6	μs
WUS Safe to Unsafe	TD1	f = 5MHz	1.6		8	μs
WUS Unsafe to Safe	TD2				1.0	μs
Head Current Propagation Delay (TD3)	TD3	L _H = 0, R _H = 0			30	ns
Head Current Asymmetry	ASYM	50% duty cycle on WDI, 1ns rise/fall time; L _H = 0, R _H = 0			2	ns
Head Current Rise/Fall Time	t _r /t _f	10% to 90% points			20	ns
Minimum WDI Rate for Safe Condition			1.0	- /4		MHz